2-2834465-0 ACTIVE

Dynamic Series | Mini Dynamic Series

TE Internal #: 2-2834465-0

PCB Mount Header, Horizontal, Wire-to-Board, 20 Position, 1.8 mm

[.071 in] Centerline, Fully Shrouded, Tin, Surface Mount, Signal,

Mini Dynamic Series

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > PCB Mount Header: Wire-to-Board











Connector System: Wire-to-Board

Number of Positions: 20

Centerline (Pitch): 1.8 mm [.071 in]

Sealable: No

PCB Mount Orientation: Horizontal

All PCB Mount Header: Wire-to-Board (15)

Features

Product Type Features

Header Type Fully Sh	
	irouded
Connector System Wire-to	o-Board
Sealable	
Connector & Contact Terminates To Printed	Circuit Board

Configuration Features

Number of Positions	20
PCB Mount Orientation	Horizontal
Number of Rows	2

Body Features

Contact Features



Contact Type	Pin
Contact Mating Area Plating Material Thickness	1 – 2.5 μm[40 – 100 μin]
Contact Mating Area Plating Material Finish	Matte
Contact Mating Area Plating Material	Tin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Method to PCB	Surface Mount
Mechanical Attachment	
Mating Alignment Type	Keyed
Mating Retention	With
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With
PCB Mount Retention Type	Retention Leg
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	PA 6T GF30
Centerline (Pitch)	1.8 mm[.071 in]
Usage Conditions	
Operating Temperature Range	-40 – 125 °C[-104 – 257 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold

Box, Tape



EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Mini Dynamic Series



Customers Also Bought

















Documents

Product Drawings

MINI DYNAMIC HDR H 20P TIN X-KEY BLK

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-2834465-0_A1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-2834465-0_A1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-2834465-0_A1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English